## TRANSMITTAL

Electronic Version v1.1

Stylesheet Version v1.1.0

Title of Invention	[BUMP LAYOUT ON SILICON CHIP]	
Application Number :		
Date :		
First Named Applica	nt: Mr. Wen-Chih Yang	
Confirmation Number:		
Attorney Docket Nu	nber: 7808-US-PA-1	

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Submitted By:	Elec. Sign.	Sign. Capacity
Dr. Belinda Lee	/Belinda Lee/	Agent
Registered Number: 46,863		

Documents being submitted:	Files
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us-request	7808-D-usrequ.xml
40 Toquoot	us-request.dtd
	us-request.xsl
us-fee-sheet	7808-D-usfees.xml
	us-fee-sheet.xsl
	us-fee-sheet.dtd
us-declaration	7808declaration1.tif
us-declaration	7808declaration2.tif
application-body	7808-D-trans.xml
	us-application-body.xsl
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	isonum.ent
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	mmlalias.ent
	soextblx.dtd
	7808US0001.tif
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	7808US0003.tif

## Comments

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